



DMN2011UFDF

## **Product Summary**

| BV <sub>DSS</sub> | BVDSS RDS(ON) MAX .            |       |
|-------------------|--------------------------------|-------|
| 201/              | $9.5 m\Omega @ V_{GS} = 4.5 V$ | 11.7A |
| 201               | 11mΩ @ V <sub>GS</sub> = 2.5V  | 10.8A |

## Description

This new generation MOSFET is designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

# Applications

- General Purpose Interfacing Switch
- Power Management Functions

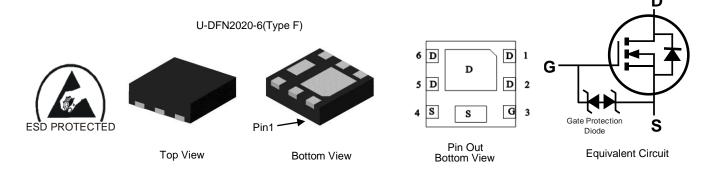
#### 20V N-CHANNEL ENHANCEMENT MODE MOSFET

#### Features

- 0.6mm Profile Ideal for Low Profile Applications
- PCB Footprint of 4mm<sup>2</sup>
- Low Gate Threshold Voltage
- Low On-Resistance
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <u>https://www.diodes.com/quality/product-definitions/</u>

## **Mechanical Data**

- Case: U-DFN2020-6
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @4
- Weight: 0.0065 grams (Approximate)



## Ordering Information (Note 4)

| Part Number    | Case                 | Reel Size (inches) | Quantity per Reel |
|----------------|----------------------|--------------------|-------------------|
| DMN2011UFDF-7  | U-DFN2020-6 (Type F) | 7                  | 3,000             |
| DMN2011UFDF-13 | U-DFN2020-6 (Type F) | 13                 | 10,000            |

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



Site 1



N2 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: H = 2020)M = Month (ex: 9 = September)

Date Code Kev

| Year  | 2016 |     | 2020 | 2021 | 2022 | 2023 | 2024 | 2025 | 2026 | 2027 | 2028 | 2029 |
|-------|------|-----|------|------|------|------|------|------|------|------|------|------|
| Code  | D    |     | Н    |      | J    | K    | L    | М    | Ν    | 0    | Р    | R    |
|       |      |     |      |      |      |      |      |      |      |      |      |      |
| Month | Jan  | Feb | Mar  | Apr  | Мау  | Jun  | Jul  | Aug  | Sep  | Oct  | Nov  | Dec  |

Site 2



D5 = Product Type Marking Code YWX = Date Code Marking Y = Year (ex: 0 = 2020) W = Week (ex: a = week 27; z represents week 52 and 53) X = Internal Code (ex: U = Monday)

Date Code Key

| Year | 2016 | <br>2020 | 2021 | 2022 | 2023 | 2024 | 2025 | 2026 | 2027 | 2028 | 2029 |
|------|------|----------|------|------|------|------|------|------|------|------|------|
| Code | 6    | <br>0    | 1    | 2    | 3    | 4    | 5    | 6    | 7    | 8    | 9    |

| Week | 1-26 | 27-52 | 53 |
|------|------|-------|----|
| Code | A-Z  | a-z   | Z  |

| Internal Code | Sun | Mon | Tue | Wed | Thu | Fri | Sat |
|---------------|-----|-----|-----|-----|-----|-----|-----|
| Code          | Т   | U   | V   | W   | Х   | Y   | Z   |



# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic                                    |                 | Symbol   | Value            | Unit         |   |
|---|-----------------|--|------------------|--------------|---|
| Drain-Source Voltage                              |                 |  | Vdss             | 20           | V |
| Gate-Source Voltage                               |                 |  | V <sub>GSS</sub> | ±12          | V |
| Continuous Drain Current (Noto 6) \/ 4.5\/        | Steady<br>State | T <sub>A</sub> = +25°C<br>T <sub>A</sub> = +70°C | lD               | 11.7<br>9.3  | А |
| Continuous Drain Current (Note 6) $V_{GS} = 4.5V$ | t<10s           | T <sub>A</sub> = +25°C<br>T <sub>A</sub> = +70°C | lo               | 14.2<br>11.4 | А |
| Pulsed Drain Current (10µs Pulse, Duty Cycle = 1% | %)              | •  | I <sub>DM</sub>  | 80           | А |
| Maximum Body Diode Continuous Current             |                 |  | ls               | 2.5          | A |
| Avalanche Current (Notes 7) L = 0.1mH             | I <sub>AS</sub> | 18   | А                |              |   |
| Avalanche Energy (Notes 7) L = 0.1mH              |                 | Eas  | 17               | mJ           |   |

# Thermal Characteristics

| Characteristic                                   |                        | Symbol           | Value       | Unit |  |
|--|------------------------|------------------|-------------|------|--|
| Total Dawar Dissinction (Note 5)                 | T <sub>A</sub> = +25°C | D-               | 0.73        | W    |  |
| Total Power Dissipation (Note 5)                 | $T_A = +70^{\circ}C$   | PD               | 0.47        | vv   |  |
| Thermal Desistance, Junction to Ambient (Note 5) | Steady State           | D                | 175         | °C/W |  |
| Thermal Resistance, Junction to Ambient (Note 5) | t<10s                  | RθJA             | 128         |      |  |
| Total Power Dissipation (Note 6)                 | $T_A = +25^{\circ}C$   | Π-               | 2.1         | W    |  |
| Total Power Dissipation (Note 6)                 | $T_A = +70^{\circ}C$   | PD               | 1.3         |      |  |
| Thermal Resistance Junction to Ambient (Note 6)  | Steady State           | D                | 61          |      |  |
| Thermal Resistance, Junction to Ambient (Note 6) | t<10s                  | RθJA             | 45          | °C/W |  |
| Thermal Resistance, Junction to Case (Note 6)    |                        | R <sub>0JC</sub> | 9.3         |      |  |
| Operating and Storage Temperature Range          |                        | TJ, TSTG         | -55 to +150 | °C   |  |

## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

|  |                     |     | -    |     | 11.14 |  |
|--|---------------------|-----|------|-----|-------|--|
| Characteristic                             | Symbol              | Min | Тур  | Max | Unit  | Test Condition                               |
| OFF CHARACTERISTICS (Note 8)               |                     |     |      | r   |       | I  |
| Drain-Source Breakdown Voltage             | BV <sub>DSS</sub>   | 20  | —    | —   | V     | $V_{GS} = 0V, I_D = 250\mu A$                |
| Zero Gate Voltage Drain Current TJ = +25°C | ldss                | —   | —    | 1   | μA    | $V_{DS} = 16V, V_{GS} = 0V$                  |
| Gate-Source Leakage                        | IGSS                | —   | —    | ±10 | μA    | $V_{GS} = \pm 10V, V_{DS} = 0V$              |
| ON CHARACTERISTICS (Note 8)                |                     |     |      |     | -     |  |
| Gate Threshold Voltage                     | V <sub>GS(TH)</sub> | 0.4 | —    | 1.0 | V     | $V_{DS} = V_{GS}, I_D = 250 \mu A$           |
|  |                     |     | 6.5  | 9.5 |       | $V_{GS} = 4.5V, I_{D} = 7A$                  |
| Static Drain-Source On-Resistance          | Design              |     | 7.5  | 11  | mΩ    | Vgs = 2.5V, ID = 7A                          |
|  | RDS(ON)             |     | 10   | 20  | 11152 | $V_{GS} = 1.8V, I_D = 5A$                    |
|  |                     |     | 15   | 35  |       | Vgs = 1.5V, ID = 3A                          |
| Diode Forward Voltage                      | Vsd                 | _   | 0.7  | 1.2 | V     | VGS = 0V, IS = 8.5A                          |
| DYNAMIC CHARACTERISTICS (Note 9)           |                     |     |      |     |       |  |
| Input Capacitance                          | Ciss                | _   | 2248 | —   | pF    |  |
| Output Capacitance                         | Coss                | _   | 295  | —   | pF    | Vps = 10V, Vgs = 0V,<br>f = 1.0MHz           |
| Reverse Transfer Capacitance 4             | Crss                | _   | 265  | —   | pF    |  |
| Gate Resistance                            | Rg                  | _   | 1.5  | —   | Ω     | $V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$         |
| Total Gate Charge (V <sub>GS</sub> = 4.5V) | Qg                  | _   | 24   | —   | nC    |  |
| Total Gate Charge (V <sub>GS</sub> = 10V)  | Qg                  | _   | 56   | —   | nC    | V 40V L 0 50                                 |
| Gate-Source Charge                         | Q <sub>gs</sub>     | _   | 3.5  | —   | nC    | V <sub>DS</sub> = 10V, I <sub>D</sub> = 8.5A |
| Gate-Drain Charge                          | Qgd                 | —   | 5.1  | —   | nC    |  |
| Turn-On Delay Time                         | t <sub>D(ON)</sub>  | _   | 3.6  | _   | ns    |  |
| Turn-On Rise Time                          | t <sub>R</sub>      |     | 2.6  | _   | ns    | Vps = 10V, Ip = 8.5A                         |
| Turn-Off Delay Time                        | tD(OFF)             | —   | 21.6 | —   | ns    | $V_{GS} = 4.5 V, R_{g} = 1.8 \Omega$         |
| Turn-Off Fall Time                         | t <sub>F</sub>      | —   | 13.5 | —   | ns    |  |
| Reverse Recovery Time                      | T <sub>RR</sub>     | —   | 12.8 | —   | ns    |  |
| Reverse Recovery Charge                    | QRR                 | —   | 6.9  | —   | nC    | IF = 8.5A, di/dt = 210A/µs                   |

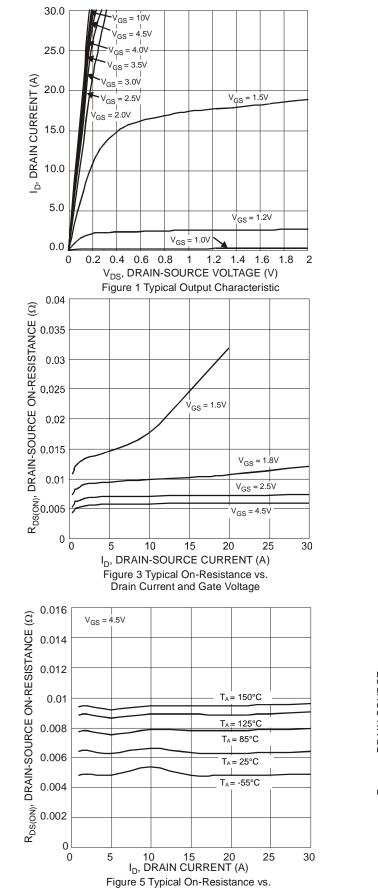
 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate. Notes:

7.  $I_{AS}$  and  $E_{AS}$  ratings are based on low frequency and duty cycles to keep  $T_J = +25^{\circ}C$ .

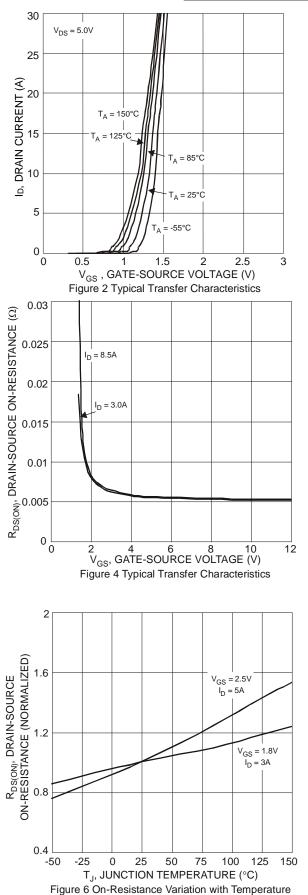
8. Short duration pulse test used to minimize self-heating effect.

9. Guaranteed by design. Not subject to product testing.



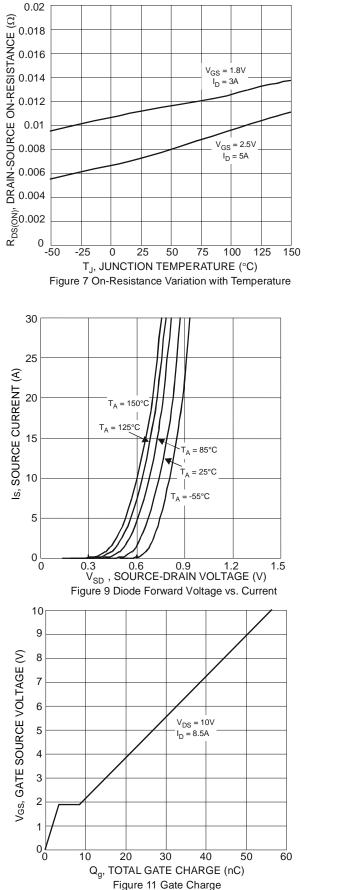


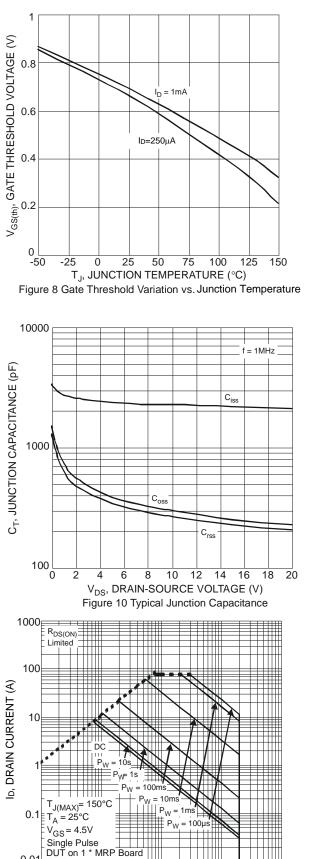
Drain Current and Temperature



## DMN2011UFDF



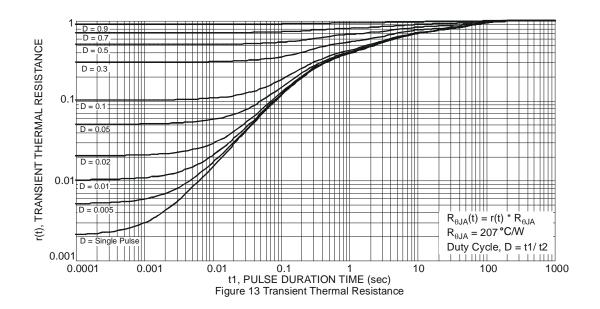




0.01 0.1 1 10 100 V<sub>DS</sub>, DRAIN-SOURCE VOLTAGE (V) Figure 12 SOA, Safe Operation Area



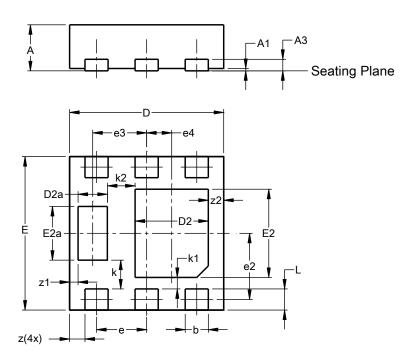






# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.



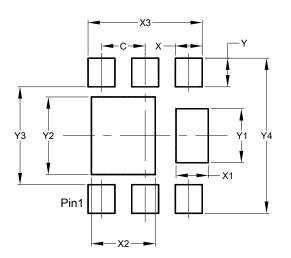
|       |                   | 2020-6       |      |  |  |  |
|-------|-------------------|--------------|------|--|--|--|
| Dim   |                   | be F)<br>Max | Тур  |  |  |  |
|       | Min               |              |      |  |  |  |
| Α     | 0.57              | 0.63         | 0.60 |  |  |  |
| A1    | 0.00              | 0.05         | 0.03 |  |  |  |
| A3    | -                 | -            | 0.15 |  |  |  |
| b     | 0.25              | 0.35         | 0.30 |  |  |  |
| D     | 1.95              | 2.05         | 2.00 |  |  |  |
| D2    | 0.85              | 1.05         | 0.95 |  |  |  |
| D2a   | 0.33              | 0.43         | 0.38 |  |  |  |
| E     | 1.95              | 2.05         | 2.00 |  |  |  |
| E2    | 1.05              | 1.25         | 1.15 |  |  |  |
| E2a   | 0.65              | 0.65 0.75 0  |      |  |  |  |
| е     | 0.65 BSC          |              |      |  |  |  |
| e2    | (                 | ).863 BS     | SC   |  |  |  |
| e3    |                   | 0.70 BS      | С    |  |  |  |
| e4    | (                 | ).325 BS     | SC   |  |  |  |
| k     |                   | 0.37 BS      | С    |  |  |  |
| k1    |                   | 0.15 BS      | -    |  |  |  |
| k2    |                   | 0.36 BS      | С    |  |  |  |
| L     | 0.225 0.325 0.275 |              |      |  |  |  |
| z     | 0.20 BSC          |              |      |  |  |  |
| z1    | 0                 | ).110 BS     | SC   |  |  |  |
| z2    |                   | 0.20 BS      | С    |  |  |  |
| All D | Dimens            | ions in      | mm   |  |  |  |

#### U-DFN2020-6 (Type F)

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### U-DFN2020-6 (Type F)



| Dimensions | Value   |
|------------|---------|
| Dimensions | (in mm) |
| С          | 0.650   |
| Х          | 0.400   |
| X1         | 0.480   |
| X2         | 0.950   |
| X3         | 1.700   |
| Y          | 0.425   |
| Y1         | 0.800   |
| Y2         | 1.150   |
| Y3         | 1.450   |
| Y4         | 2.300   |



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